

SiC JFET Division

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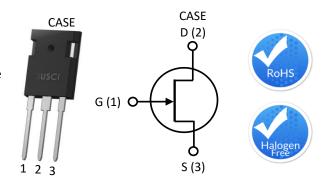


Silicon Carbide (SiC) JFET - EliteSiC, Power N-Channel, TO-247-3L, 650 V, 80 mohm | UJ3N065080K3S

Datasheet

Description

United Silicon Carbide, Inc offers the high-performance G3 SiC normally-on JFET transistors. This series exhibits ultra-low on resistance ($R_{DS(ON)}$) and gate charge (Q_G) allowing for low conduction and switching loss. The device normally-on characteristics with low $R_{DS(ON)}$ at V_{GS} = 0 V is also ideal for current protection circuits without the need for active control, as well as for cascode operation.



Part Number	Package	Marking
UJ3N065080K3S	TO-247-3L	UJ3N065080K3S

Features

- Typical on-resistance R_{DS(on),typ} of 80mΩ
- Voltage controlled
- Maximum operating temperature of 175°C
- Extremely fast switching not dependent on temperature
- Low gate charge
- Low intrinsic capacitance
- ◆ RoHS compliant
- AECQ Qualified

Typical Applications

- Over current protection circuits
- DC-AC inverters
- Switch mode power supplies
- Power factor correction modules
- Motor drives
- Induction heating

Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units	
Drain-source voltage	V _{DS}		650	V	
Gate-source voltage	.,	DC	-20 to +3	V	
	V _{GS}	AC (1)	-20 to +20		
Continuous drain current (2)		T _C = 25°C	32	А	
	I _D	T _C = 100°C	24	Α	
Pulsed drain current ⁽³⁾	I _{DM}	T _C = 25°C	72	А	
Power dissipation	P _{tot}	T _C =25°C	190	W	
Maximum junction temperature	T _{J,max}		175	°C	
Operating and storage temperature	T _J , T _{STG}		-55 to 175	°C	
Max. lead temperature for soldering, 1/8" from case for 5 seconds	T _L		250	°C	

- (1) +20V AC rating applies for turn-on pulses <200ns applied with external $R_G > 1\Omega$.
- (2) Limited by T_{J,max}
- (3) Pulse width t_p limited by T_{J,max}



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Electrical Characteristics (T_J = +25°C unless otherwise specified)

Typical Performance - Static

Parameter	Symbol	Test Conditions	Value			Units	
raiailletei Syllibol lest Colle		rest conditions	Min	Тур	Max	Ullits	
Drain-source breakdown voltage	BV _{DS}	V_{GS} = - 20V, I_D =1mA	650			V	
Total drain leakage current	I _D	$V_{DS} = 650V$, $V_{GS} = -20V$, $T_{J} = 25$ °C		8	60		
		$V_{DS} = 650V$, $V_{GS} = -20V$, $T_{J} = 175$ °C		30	μΑ	μΑ	
Total gate leakage current	I _G	V _{GS} =-20V, T _j =25°C		10	50	μА	
		V _{GS} =-20V, T _j =175°C		32			
Drain-source on-resistance	R _{DS(on)}	$V_{GS}=2V$, $I_D=10A$, $T_J=25^{\circ}C$		68		mΩ	
		V_{GS} =0V, I_D =10A, T_J = 25°C		80	95		
		$V_{GS}=2V, I_{D}=10A,$ $T_{J}=175^{\circ}C$		114			
		V_{GS} =0V, I_{D} =10A, T_{J} = 175°C		130			
Gate threshold voltage	$V_{G(th)}$	$V_{DS} = 5V$, $I_D = 20mA$	-14	-11.5	-6	V	
Gate resistance	R_{G}	f = 1MHz, open drain		3.7		Ω	

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Typical Performance - Dynamic

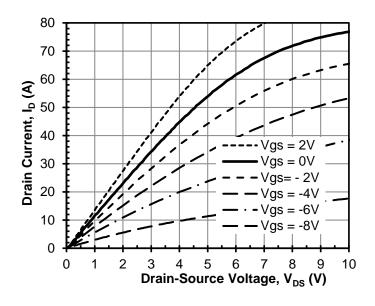
Parameter	symbol	Test Conditions	Value			- Units		
- Tarameter - Syn		rest conditions	Min	Тур	Max	Ullits		
Input capacitance	C _{iss}	V _{DS} = 100V,		630		pF		
Output capacitance	C _{oss}	V _{GS} = -20V,		94				
Reverse transfer capacitance	C _{rss}	f = 100kHz		88				
Effective output capacitance, energy related	C _{oss(er)}	$V_{DS} = 0V \text{ to } 400V,$ $V_{GS} = -20V$		69		pF		
Total gate charge	Q_{G}	1/ 400\/ 1 244		75				
Gate-drain charge	Q_{GD}	V_{DS} =400V, I_{D} = 24A,		43		nC		
Gate-source charge	Q_{GS}	V _{GS} =-18V to 0V		7				
Turn-on delay time	t _{d(on)}	V_{DS} =400V, I_{D} =24A, Gate Driver =-18V to 0V, $R_{G,EXT}$ = 1 Ω , Inductive Load,		6		- ns		
Rise time	t _r			25				
Turn-off delay time	t _{d(off)}			14				
Fall time	t _f			31				
Turn-on energy	E _{ON}	FWD: UJ3D06510TS T _J = 25°C		149		μ		
Turn-off energy	E _{OFF}			183				
Total switching energy	E _{TOTAL}			332				
Turn-on delay time	t _{d(on)}	$V_{DS}\text{=}400\text{V}, I_{D}\text{=}24\text{A},$ Gate Driver =-18V to 0V, $R_{G,\text{EXT}} = 1\Omega,$ Inductive Load, $FWD\text{:} UJ3D06510TS$ $T_{J} = 150^{\circ}\text{C}$		6				
Rise time	t _r			24		ns		
Turn-off delay time	t _{d(off)}			14				
Fall time	t _f			14				
Turn-on energy	E _{ON}			134				
Turn-off energy	E _{OFF}			103		μͿ		
Total switching energy	E _{TOTAL}			237				

Thermal Characteristics

Parameter	symbol	Test Conditions	Value			Units
raranieter			Min	Тур	Max	Ullits
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.61	0.79	°C/W



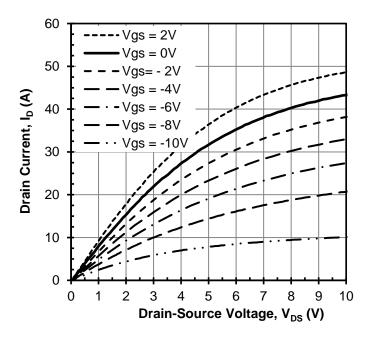
Typical Performance Diagrams

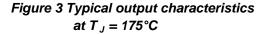


80 70 60 Drain Current, I_D (A) 50 40 Vgs = 2V Vgs = 0V30 Vgs = -2V. 20 Vgs = -4VVgs = -6V10 Vas = -8V3 5 7 8 10 6 Drain-Source Voltage, V_{DS} (V)

Figure 1 Typical output characteristics at $T_J = 55$ °C

Figure 2 Typical output characteristics at $T_J = 25$ °C





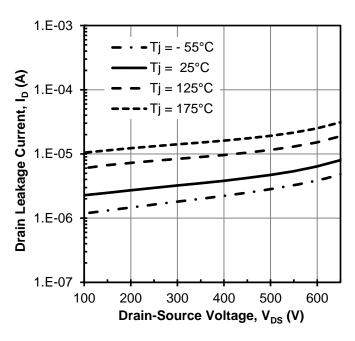


Figure 4 Typical drain-source leakage at $V_{GS} = -20V$

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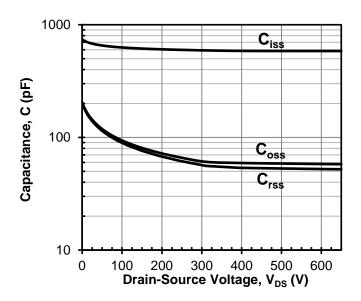


Figure 5 Typical capacitances at 100kHz and $V_{GS} = -20V$

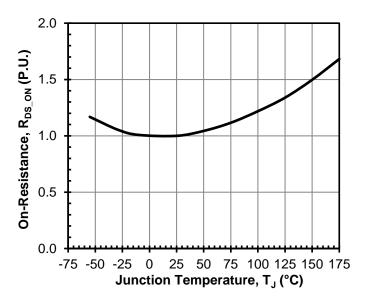


Figure 7 Normalized on-resistance vs. temperature at $V_{GS} = 0V$ and $I_D = 10A$

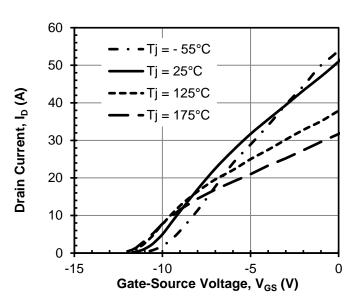


Figure 6 Typical transfer characteristics at $V_{DS} = 5V$

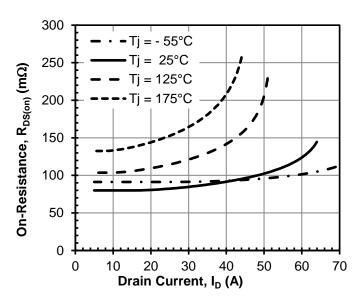


Figure 8 Typical drain-source on-resistance at $V_{GS} = 0V$

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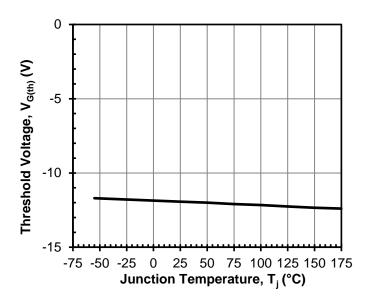


Figure 9 Threshold voltage vs. Tj at $V_{DS} = 5V$ and $I_D = 20mA$

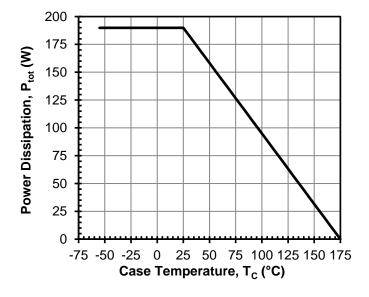


Figure 11 Total power Dissipation

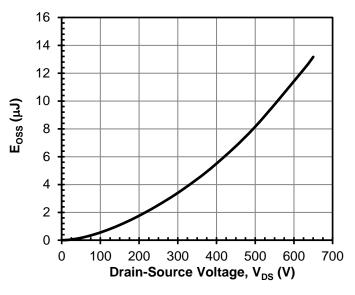


Figure 10 Typical stored energy in C_{OSS} at $V_{GS} = -20V$

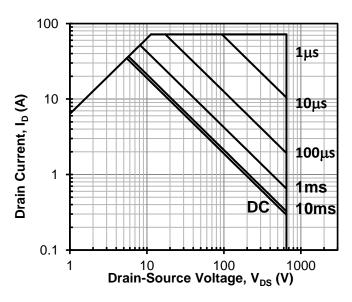


Figure 12 Safe operation area $T_c = 25$ °C, Parameter t_p

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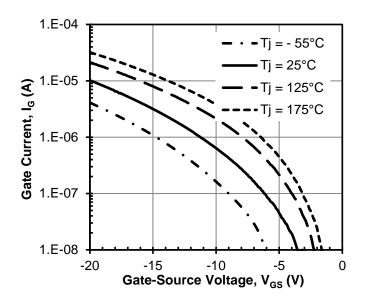


Figure 13 Typical gate leakage current at $V_{DS} = 0V$

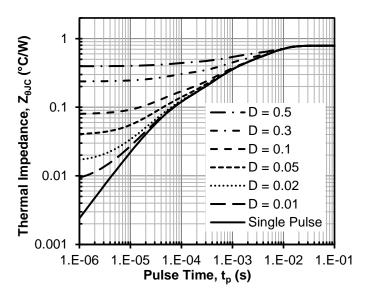


Figure 15 Maximum transient thermal impedance

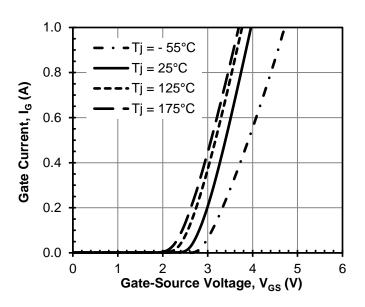


Figure 14 Typical gate forward current at $V_{DS} = 0V$

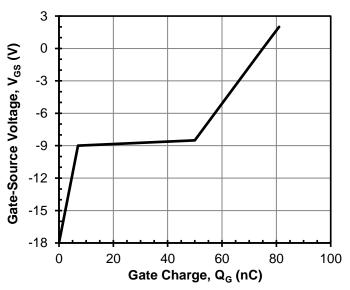
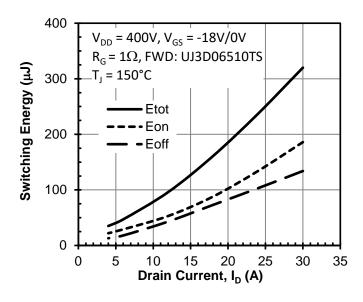


Figure 16 Typical gate charge at $V_{DS} = 400V$ and $I_D = 24A$





600 $V_{DD} = 400V$, $V_{GS} = -18V/0V$ $I_D = 24A, T_1 = 150^{\circ}C$ 500 Switching Energy (μJ) FWD: UJ3D06510TS 400 300 200 Etot Eon 100 - Eoff 0 2 4 8 10 0 Gate Resistor, $R_{G}(\Omega)$

Figure 17 Clamped inductive switching energy vs. drain current at $T_J = 150$ °C

Figure 18 Clamped inductive switching energy vs. gate resistor R_G

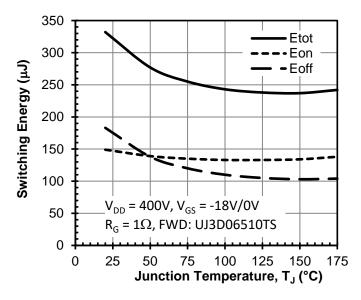


Figure 19 Clamped inductive switching energy vs. junction temperature at $I_D = 24A$

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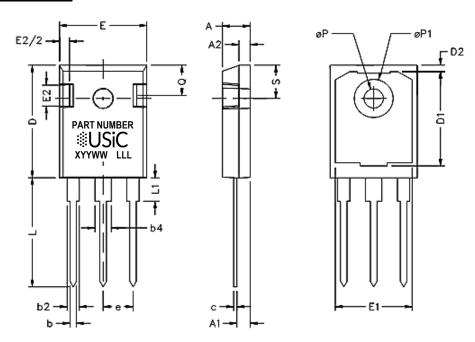
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TO-247-3L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

PACKAGE OUTLINE

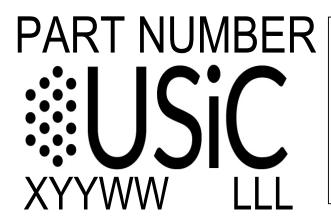


SYM	INC	HES	MILLIMETERS		
	MIN	MAX	MAX MIN		
Α	0.185	0.209	4.699	5.309	
A1	0.087	0.102	2.21	2.61	
A2	0.059	0.098	1.499	2.489	
b	0.039	0.055	0.991	1.397	
b2	0.065	0.094	1.651	2.388	
b4	0.102	0.135	2.591	3.429	
С	0.015	0.035	0.381	0.889	
D	0.819	0.845	20.803	21.463	
D1	0.515	-	13.081	-	
D2	0.02	0.053	0.508	1.346	
E	0.61	0.64	15.494	16.256	
е	0.214	4 BSC	5.44	BSC	
E1	0.53	-	13.462	-	
E2	0.135	0.157	3.429	3.988	
L	0.78	0.8	19.812	20.32	
L1	ı	0.177	ī	4.496	
ØΡ	0.14	0.144	3.556	3.658	
ØP1	0.278	0.291	7.061	7.391	
Q	0.212	0.244	5.385	6.198	
S	0.243	3 BSC	BSC		



TO-247-3L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

PART MARKING



PART NUMBER = REFER TO
DS PN DECODER FOR DETAILS

X = ASSEMBLY SITE

YY = YEAR

WW = WORK WEEK

LLL = LOT ID

PACKING TYPE

ANTI-STATIC TUBE

QUANTITY /TUBE: 30 UNITS

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